

SB2060 SCHOTTKY RECTIFIER

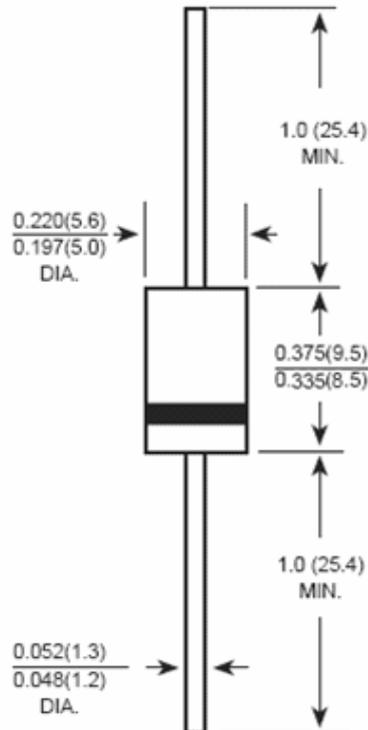
Applications:

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Disk drives
- Battery charging

Features:

- Schottky Barrier Chip
- Ideally Suited for Automatic Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low Voltage Application
- Guard Ring Die Construction
- Plastic Case Material has UL Flammability
- Classification Rating 94V-0
- Green Products in Compliance with the RoHS Directive
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Dimensions: In Inches / mm



DO-201AD



Marking Diagram:



Where XXXXX is YYWWL

- SB = Device Type
- 20 = Forward Current (20A)
- 60 = Reverse Voltage (60V)
- SSG = SSG
- YY = Year
- WW = Week
- L = Lot Number

Cautions : Molding resin
Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
SB2060	DO-201AD (Pb-Free)	1250 pcs / Tape

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.



Maximum Ratings and Electrical Characteristics @ $T_A=25^{\circ}\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	SB2060	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	60	V
Maximum RMS Voltage	V_{RMS}	42	V
Average Rectified Output Current (Note 1) @ $T_C = 135^{\circ}\text{C}$	$I_{F(AV)}$	20	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	300	A
Forward Voltage @ $I_F = 20\text{A}, T_A = 25^{\circ}\text{C}$ @ $I_F = 20\text{A}, T_A = 125^{\circ}\text{C}$	V_{FM}	0.70 0.60	V
Peak Reverse Current At Rated DC Blocking Voltage @ $T_A = 25^{\circ}\text{C}$ @ $T_A = 125^{\circ}\text{C}$	I_{RM}	1 40	mA
Typical Thermal Resistance Junction to Case	$R_{\theta JC}$	2	$^{\circ}\text{C}/\text{W}$
Storage Temperature Range	T_{STG}, T_J	-55 to +150	$^{\circ}\text{C}$
Approximate Weight	wt	1.02	g
Case Style	DO-201AD		

Note:1. Mount on Cu-Pad Size 5mm×5mm on P.C.B.



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